

Wafer-scale nanofabrication of single telecom quantum emitters in silicon

M. Hollenbach^{1,2}, N. Klingner¹, N. S. Jagtap^{1,2}, L. Bischoff¹, C. Fowley¹, U. Kentsch¹, G. Hlawacek¹, A. Erbe¹, N.V. Abrosimov³, M. Helm^{1,2}, Y. Berencén¹ and G.V. Astakhov¹

¹Helmholtz-Zentrum Dresden-Rossendorf,
Institute of Ion Beam Physics and Materials Research,
Bautzner Landstr. 400, 01328 Dresden, Germany

²Technische Universität Dresden, 01062 Dresden, Germany

³Leibniz-Institut für Kristallzüchtung (IKZ), 12489 Berlin, Germany

LEAPS meets Quantum Technology
15-20 May 2022

**FWIM - Quantum Technology and Materials
PhD Student**



1. Motivation

2. State of the art: G-center in Silicon

- **Atomic configuration**
- **Creation**

3. Experimental setup

- **Single-defect spectroscopy (CFM)**
- **Hanbury-Brown & Twiss (HBT) experiment**

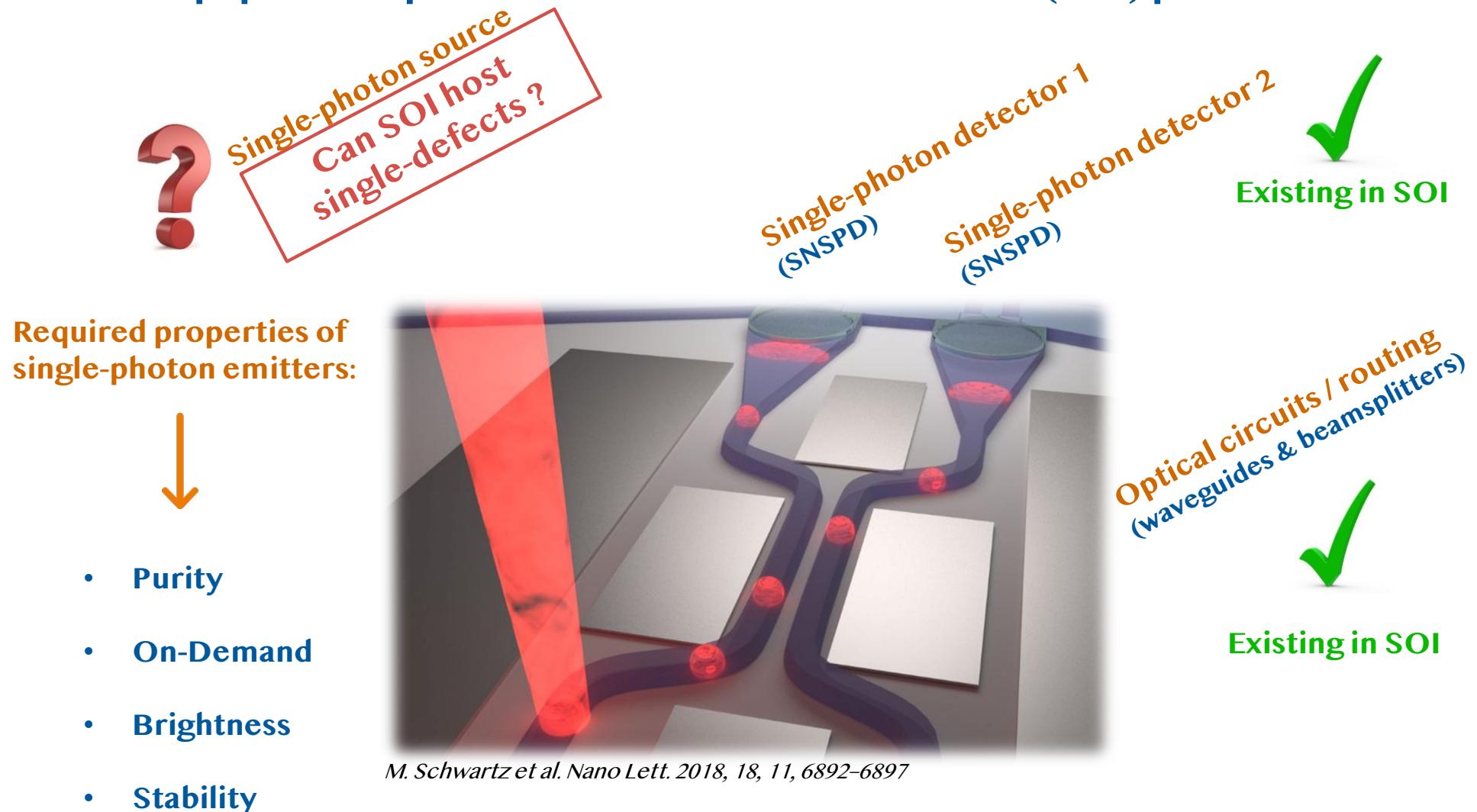
4. Experimental results

- **FIB writing of single telecom quantum emitters (FIB)**
- **Wafer-scale fabrication of single telecom quantum emitters (PMMA)**

5. Outlook

6. Summary

On-chip quantum photonics in a silicon on insulator (SOI) platform



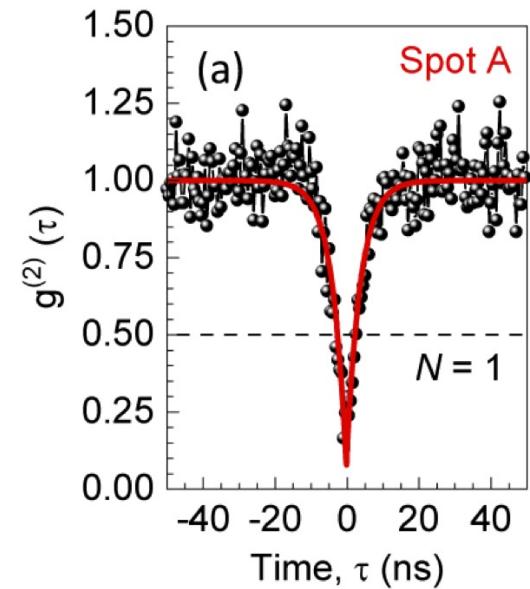
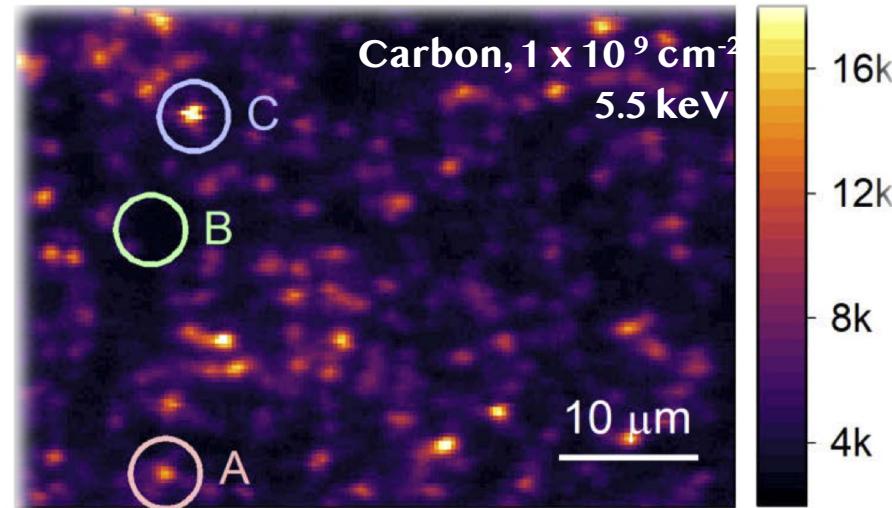
Monolithic semiconductor - superconductor quantum circuit in silicon

On-chip quantum photonics in a silicon on insulator (SOI) platform

Single-photon source
Can SOI host
single-defects?
✓
Existing in SOI

Required properties of
single-photon emitters:

- Purity
- On-Demand
- Brightness
- Stability



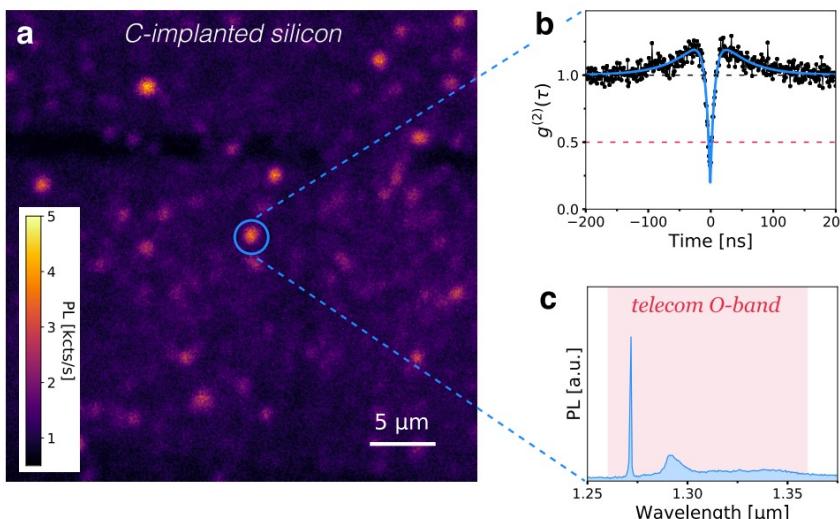
M. Hollenbach et al. : "Engineering telecom single-photon emitters in silicon for scalable quantum photonics",
Optics Express Vol. 28, Issue 18, pp. 26111-26121 (2020)

How to create “artificial atoms“ in an SOI wafer?

Laboratoire Charles Coulomb,
France

Single artificial atoms in silicon emitting at telecom wavelengths
Methods

W. Redjem^{1,*}, A. Durand^{1,*}, T. Herzog², A. Benali³, S. Pezzagna², J. Meijer², A. Yu. Kuznetsov⁴, H. S. Nguyen⁵, S. Cueff⁵, J.-M. Gérard⁶, I. Robert-Philip¹, B. Gil¹, D. Caliste⁶, P. Pochet⁶, M. Abbarchi³, V. Jacques¹, A. Dréau^{1,†} and G. Cassabois¹
¹Laboratoire Charles Coulomb, Université de Montpellier and CNRS, 34095 Montpellier, France



⇒ High fluence C-broad-beam irradiation
+ RTA at 1000 °C ($5 \times 10^{13} \text{ cm}^{-2}$, 36 keV)

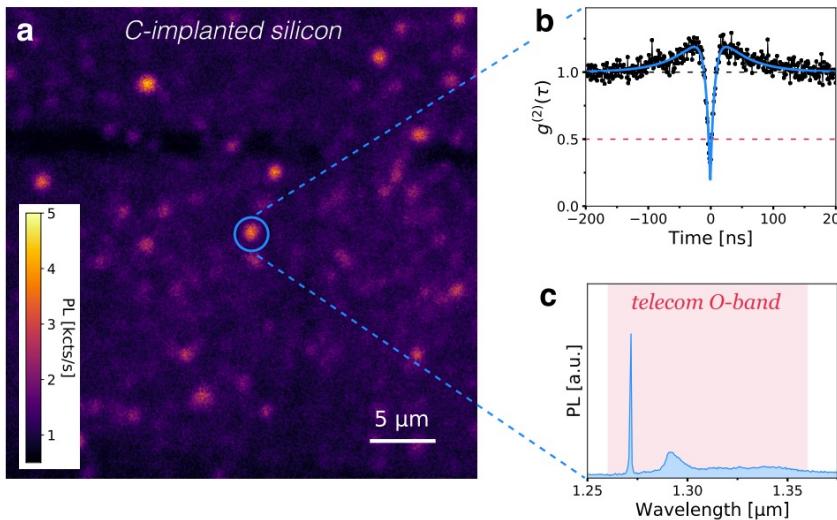
Nature Electronics volume 3, pages 738–743 (2020)

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Massachusetts Institute of Technology, USA

Individually Addressable Artificial Atoms in Silicon Photonics

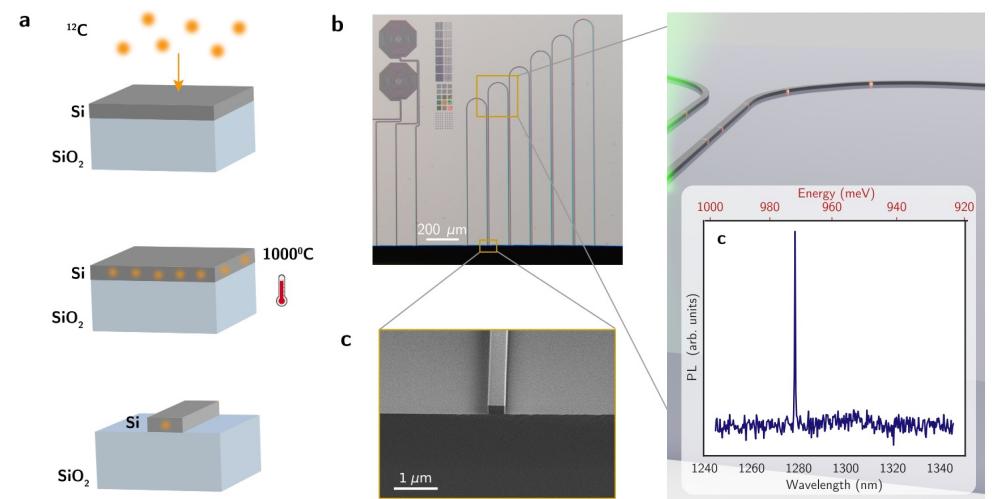
Mihika Prabhu^{1,†}, Carlos Errando-Herranz^{1,2,†}, Lorenzo De Santis^{1,3},

Ian Christen¹, Changchen Chen¹, and Dirk Englund^{1,*}

¹Massachusetts Institute of Technology, Cambridge, USA

²University of Münster, Münster, Germany

³QuTech, Delft University of Technology, Delft, Netherlands



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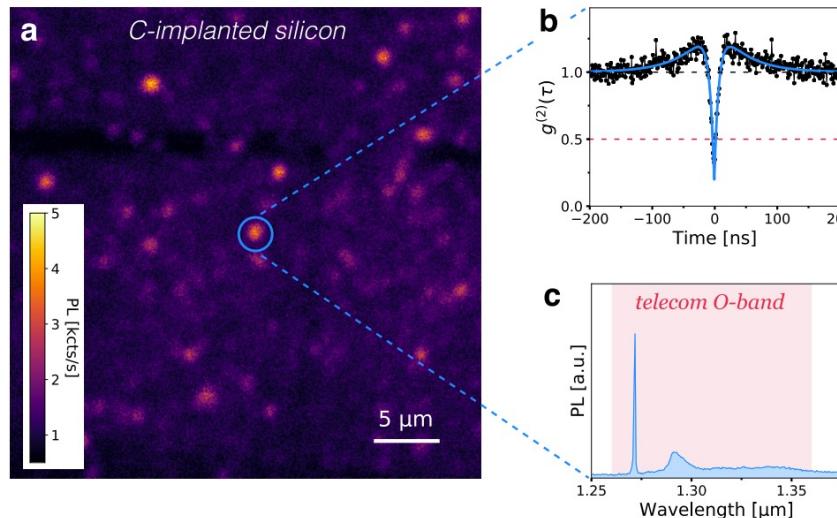
arXiv:2202.02342v1 (2022)

How to create “artificial atoms“ in an SOI wafer?

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Single artificial atoms in silicon emitting at telecom wavelengths
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Individually Addressable Artificial Atoms in Silicon Photonics

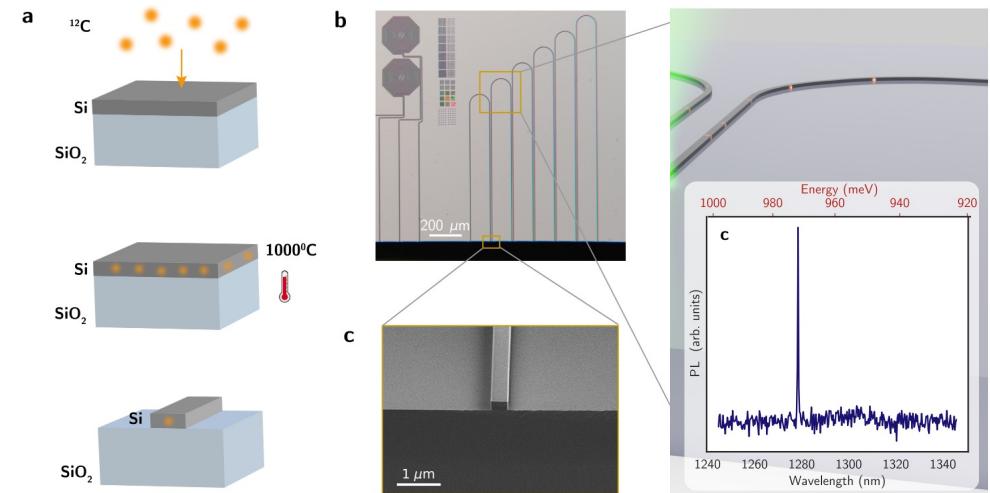
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⇒ High fluence C-broad-beam irradiation
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Random positioning of single defects - No controlled creation !

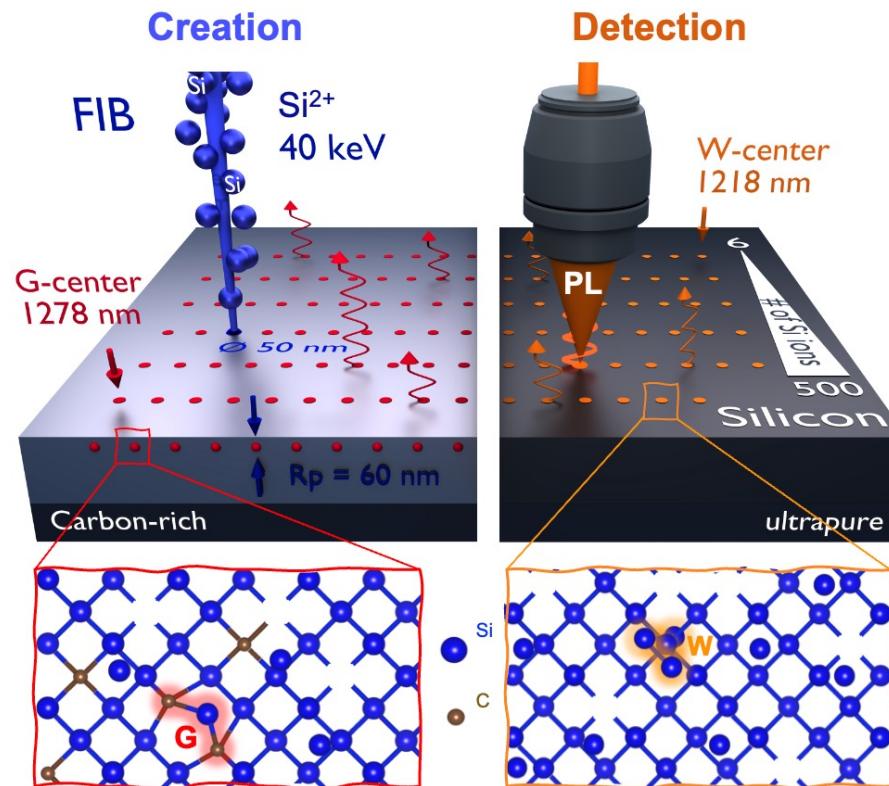
On-chip quantum photonics in a silicon on insulator (SOI) platform

Can we create single defects in silicon at desired locations ?

Required properties of single-photon emitters:



- Purity
- On-Demand
- Brightness
- Stability



Requirements for very large-scale integrated Silicon photonics:



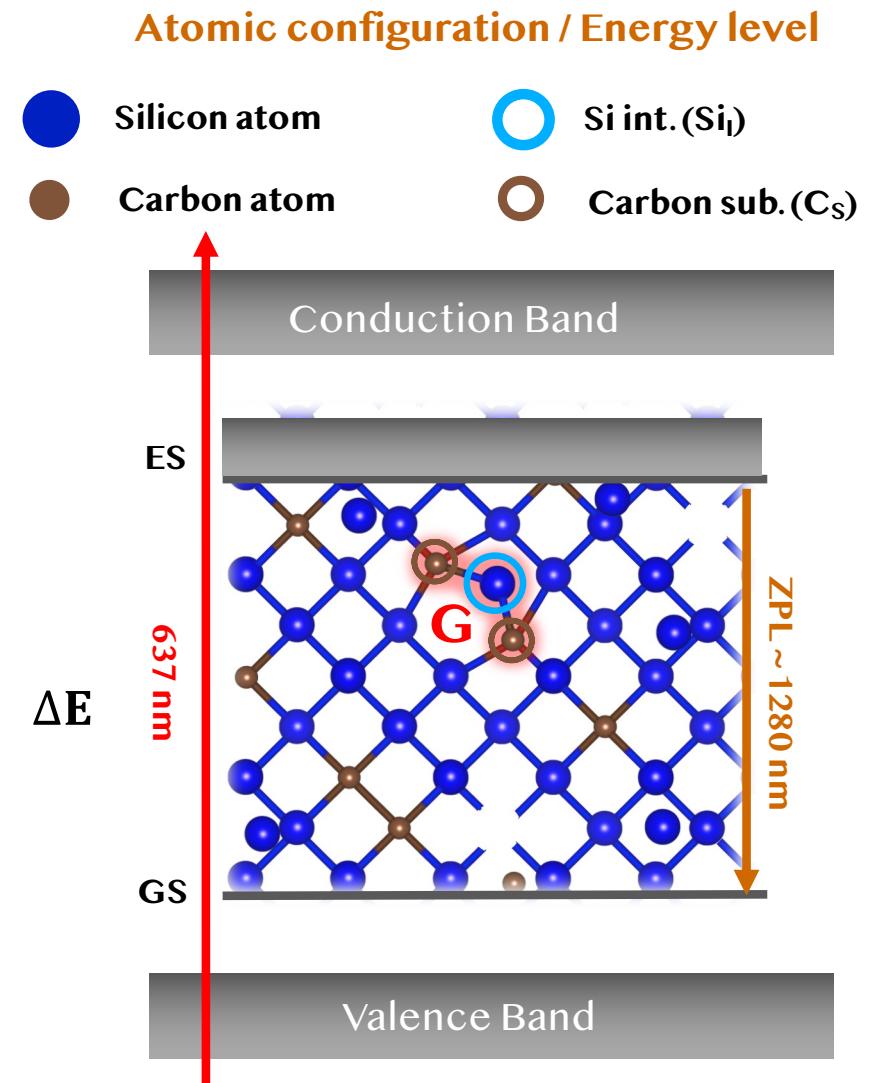
- Local creation
- Scalability
- Accuracy
- Efficiency

Focus of the talk: Controllable creation of single G-centers with sub-100-nm precision

M. Hollenbach et al. : "Wafer-scale nanofabrication of telecom single-photon emitters in silicon", arXiv:2204.13173 (April 2022)

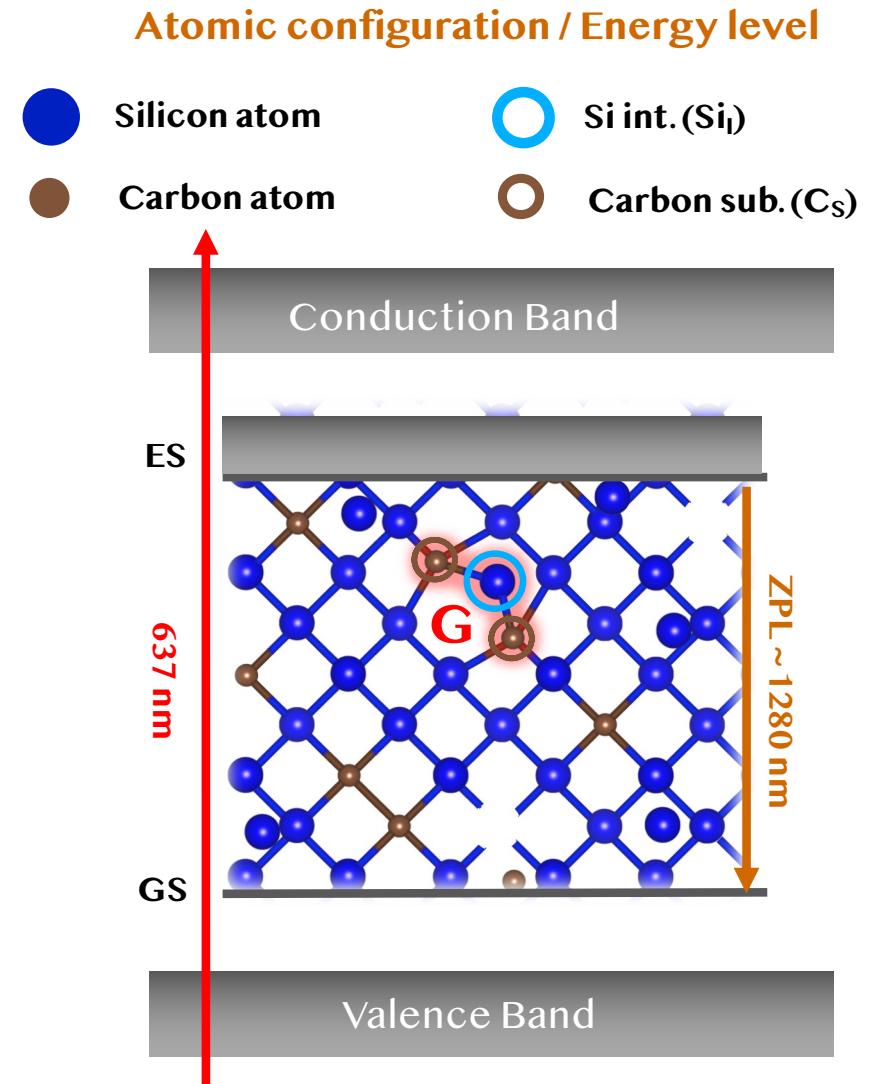
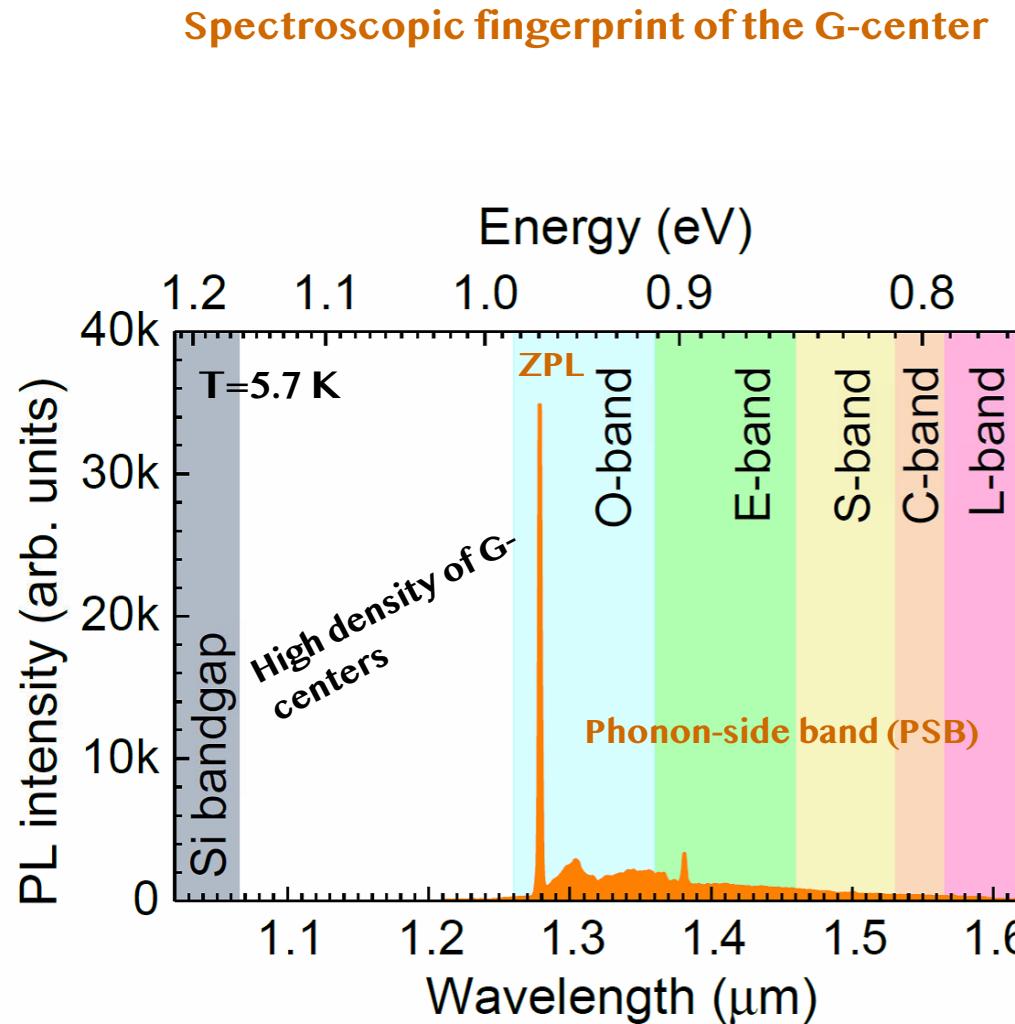
What is the G-center?... carbon related atomic-sized luminescence center in silicon

- **G-Center: substitutional-substitutional carbon pairs ($C_S - C_S$) with interstitial silicones (Si_I)**
- **Localization within Si bandgap:**
Optically active
- **Zero-phonon line (ZPL) emission at 1278 nm**
- **Spectrally narrowest ZPL in solid state (^{28}Si)**
- **Low-temperature emission in the Telecommunication O-Band**



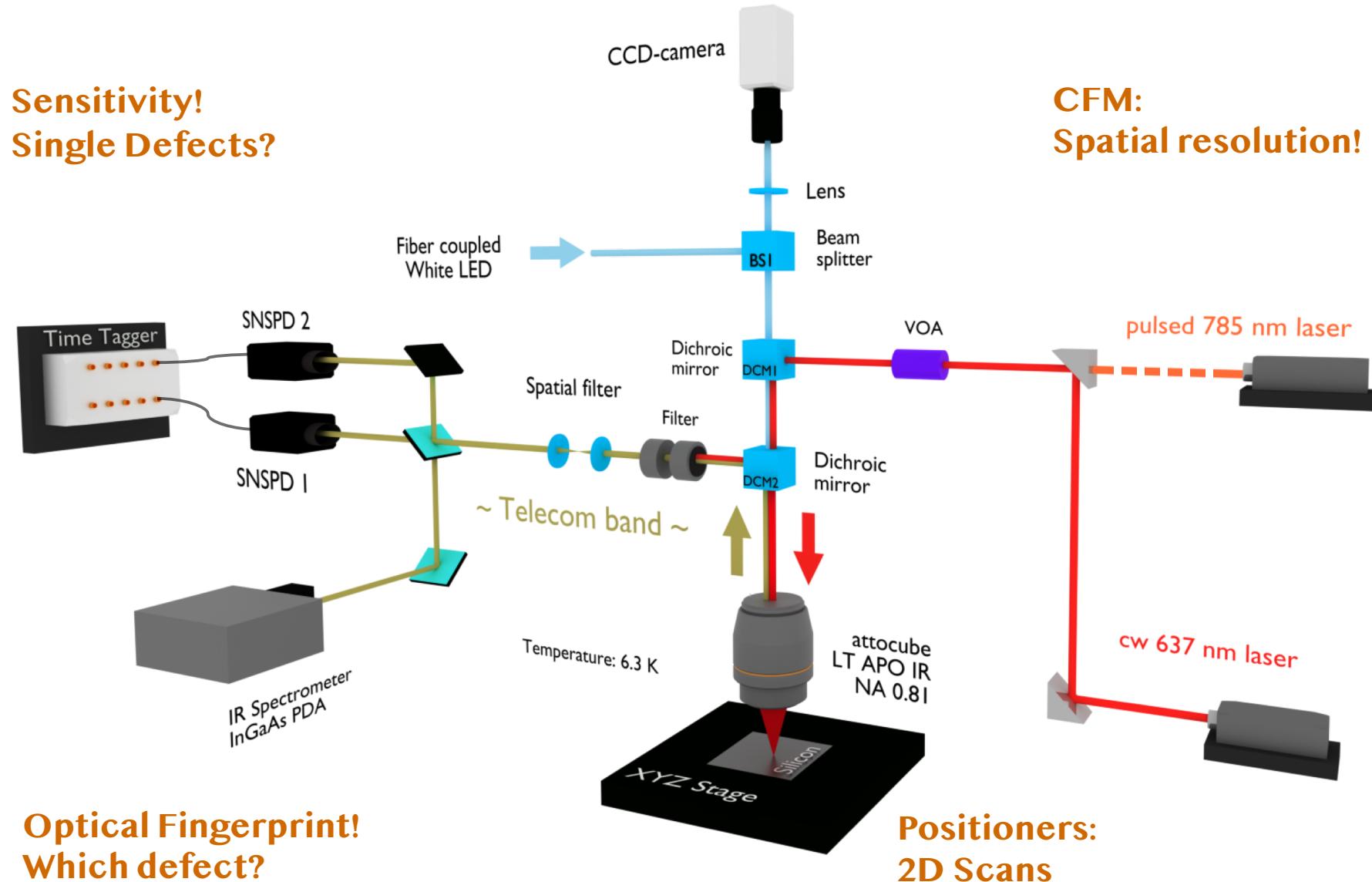
P. Udvarhelyi et al. : "Identification of a Telecom Wavelength Single Photon Emitter in Silicon", Phys. Rev. Lett. 127, 196402 (2021)

What is the G-center?... emitting in the telecom O-band (1260 - 1360 nm)



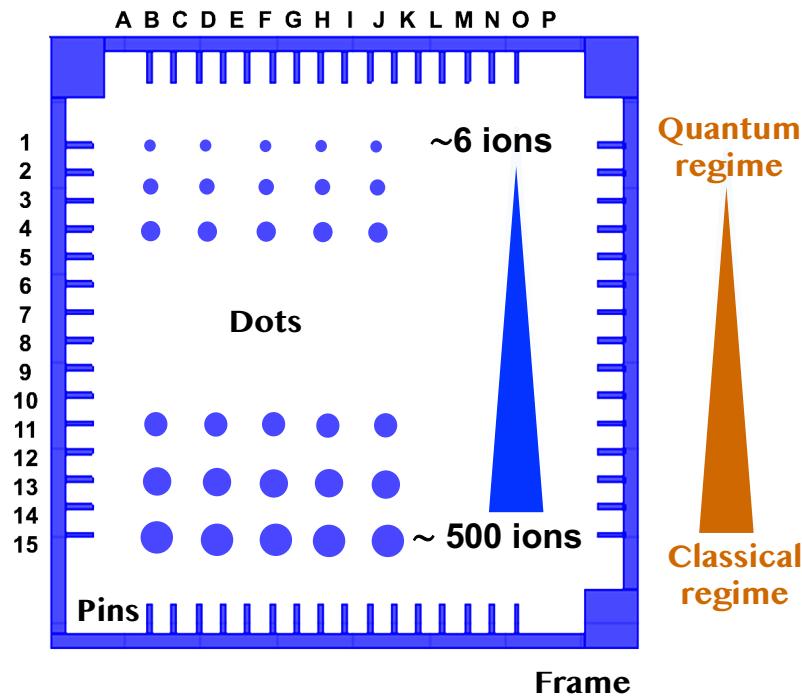
⇒ Excellent light source for fiber-optic communications

How to read-out the G-center? ...home-built LT confocal microscope (CFM)



Focused ion-beam writing of G-centers using Si-FIB (LMAIS)

Irradiation layout

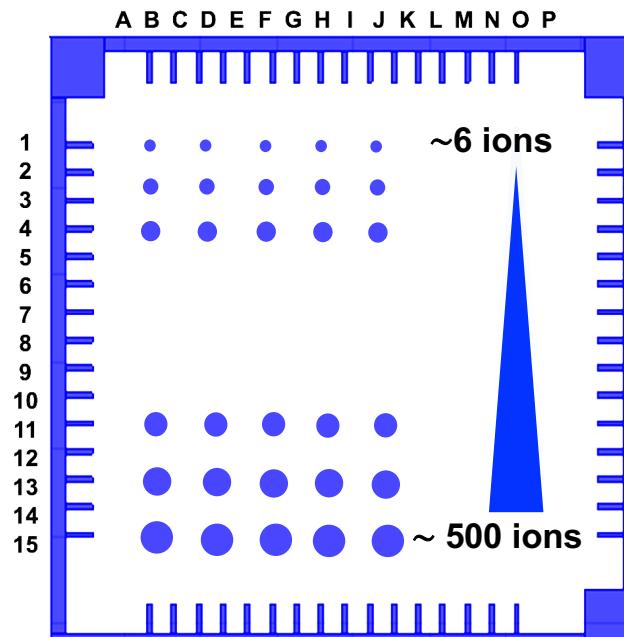


Single dot writing
(15 x 16 spots)

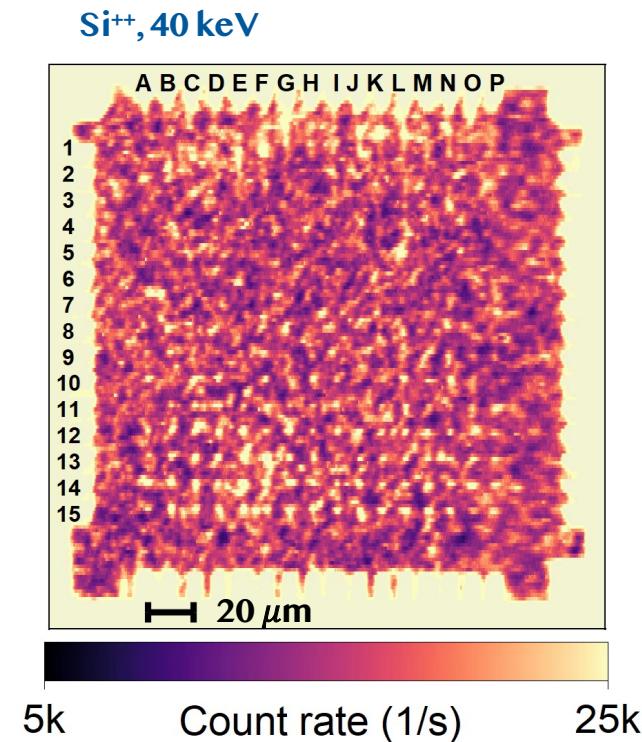
Special thanks to N. Klingner
and L. Bischoff

Focused ion-beam writing of G-centers using Si-FIB (LMAIS)

Irradiation layout



2D confocal photoluminescence maps

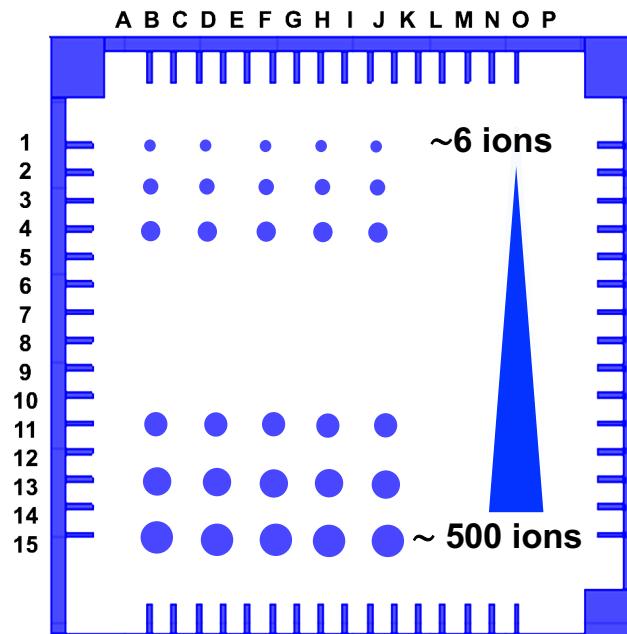


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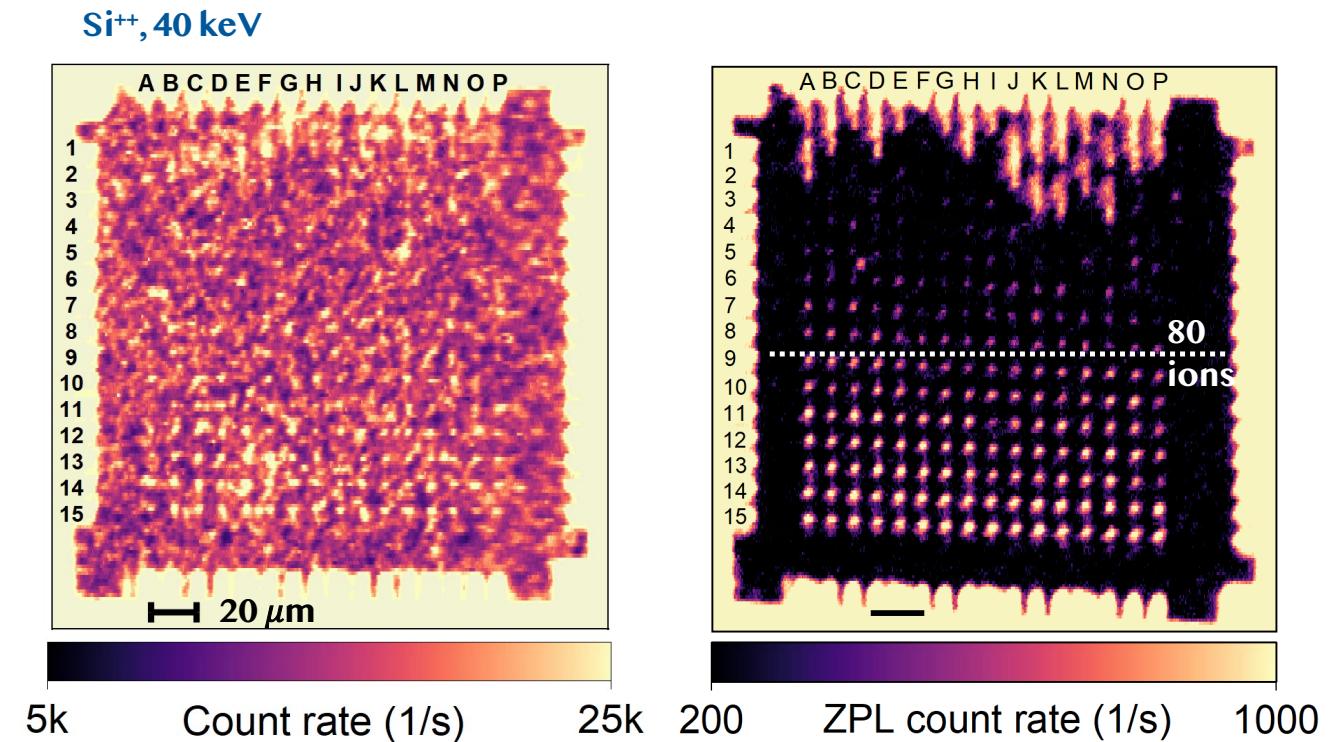
LP 1250 nm

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2D confocal photoluminescence maps



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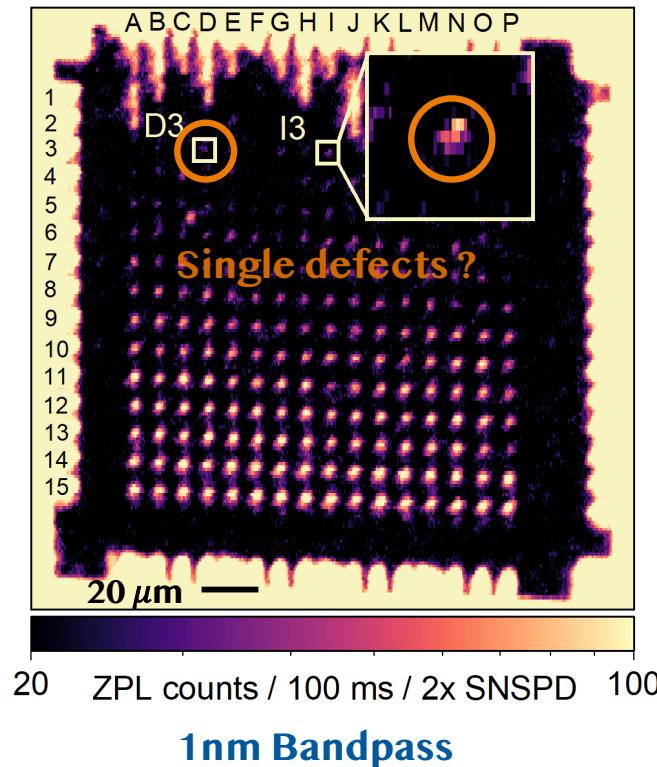
1nm Bandpass
tuned to the ZPL

Local irradiation sites are masked by the background fluorescence \Rightarrow 1nm BP filter

Focused ion-beam writing of G-centers using Si-FIB (LMAIS)

2D confocal PL map

Line 3: (25 ± 5) Si ions/spot

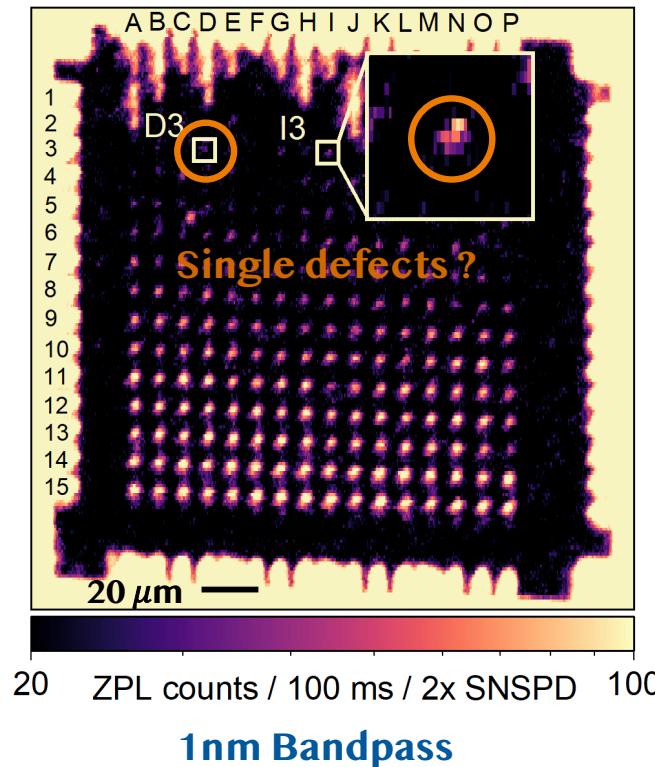


Diffraction-limited spots = single telecom photon emitter ?

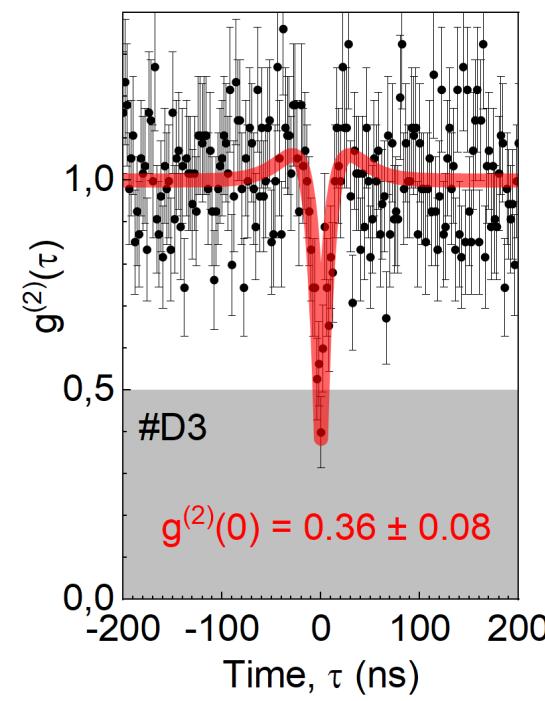
Focused ion-beam writing of G-centers using Si-FIB (LMAIS)

2D confocal PL map

Line 3: (25 ± 5) Si ions/spot



HBT - Interferometry

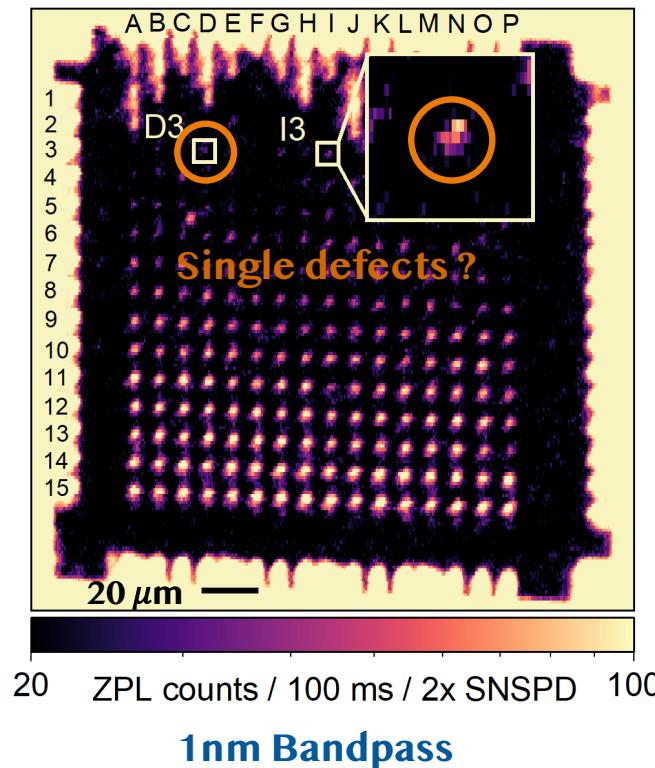


Single Emitter : Never two photons at a time = no coincident counts at zero time delay

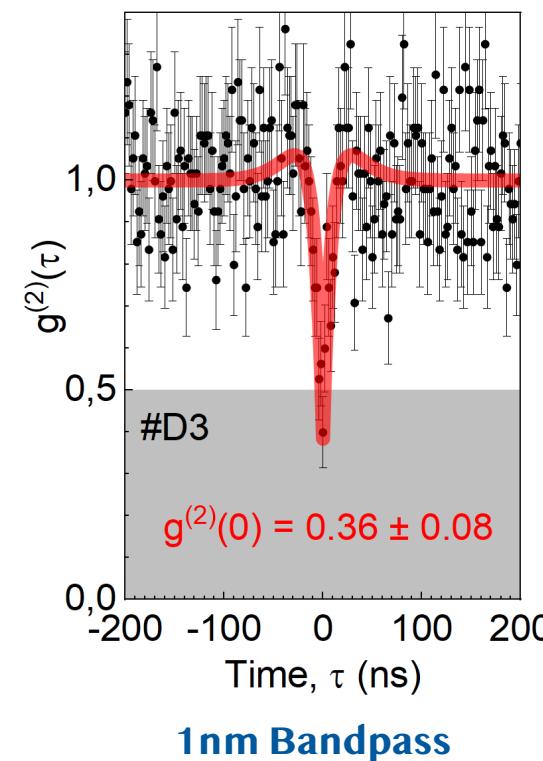
Focused ion-beam writing of G-centers using Si-FIB (LMAIS)

2D confocal PL map

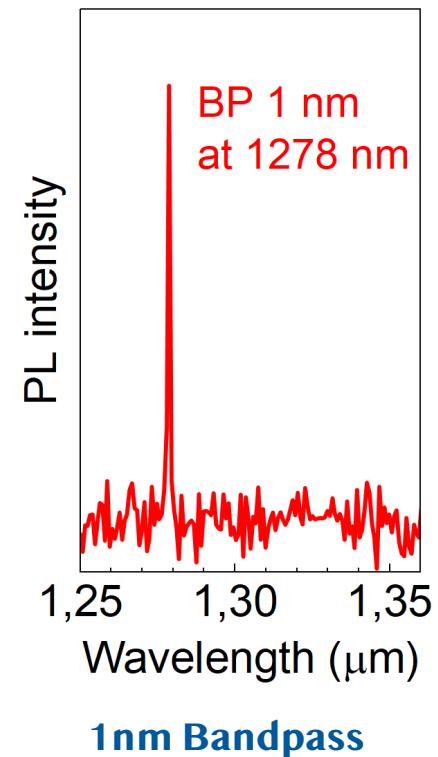
Line 3: (25 ± 5) Si ions/spot



HBT - Interferometry



ZPL contribution to the PL spectrum

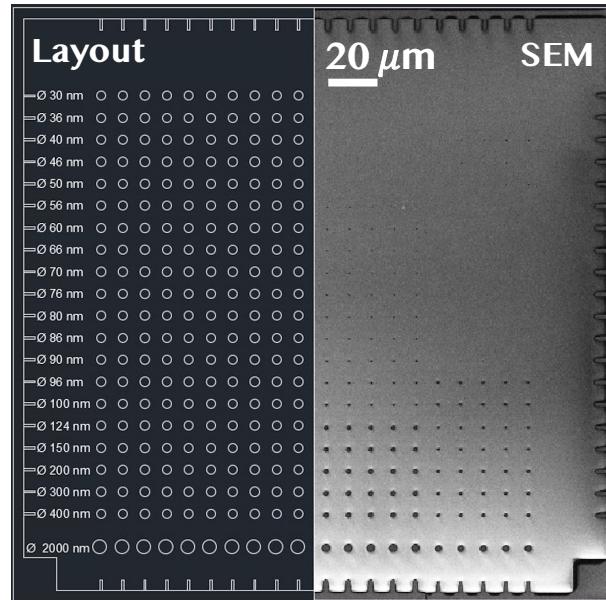


First demonstration of controllable fabrication of single-telecom photon emitters in Si !

Wafer-scale nanofabrication of single telecom quantum emitters - Broad beam Si ions

PMMA design / SEM image

Si^{++} , $1 \times 10^{12} \text{ cm}^{-2}$, 40 keV



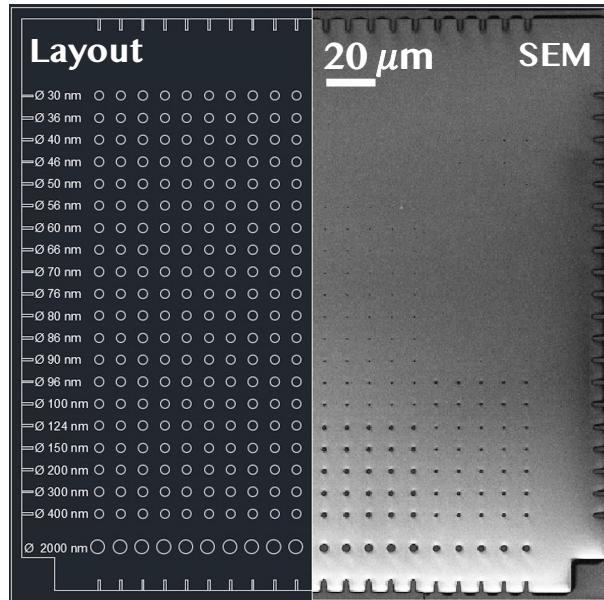
Nanohole layout
Mask implantation (20 x 20 sites)

Special thanks to
N. Jagtap, C. Fowley and U. Kentsch

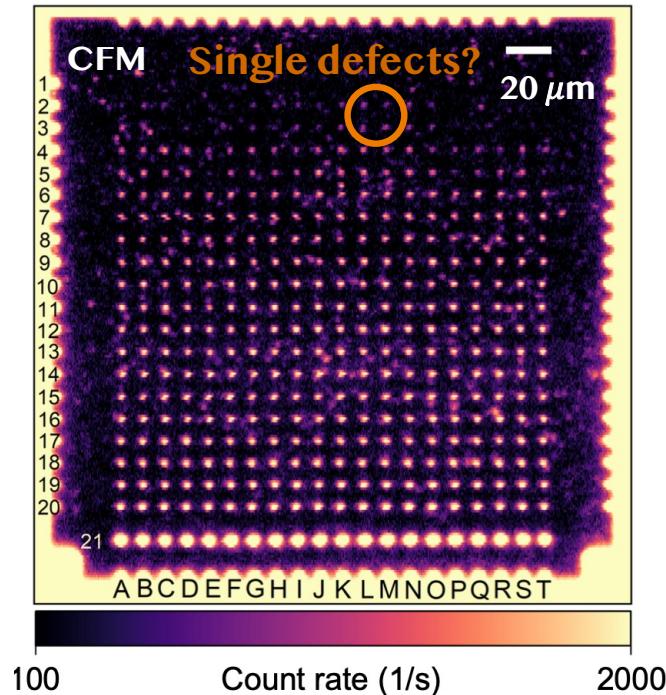
Wafer-scale nanofabrication of single telecom quantum emitters - Broad beam Si ions

PMMA design / SEM image

Si^{++} , $1 \times 10^{12} \text{ cm}^{-2}$, 40 keV



2D confocal PL map



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Mask implantation (20 x 20 sites)

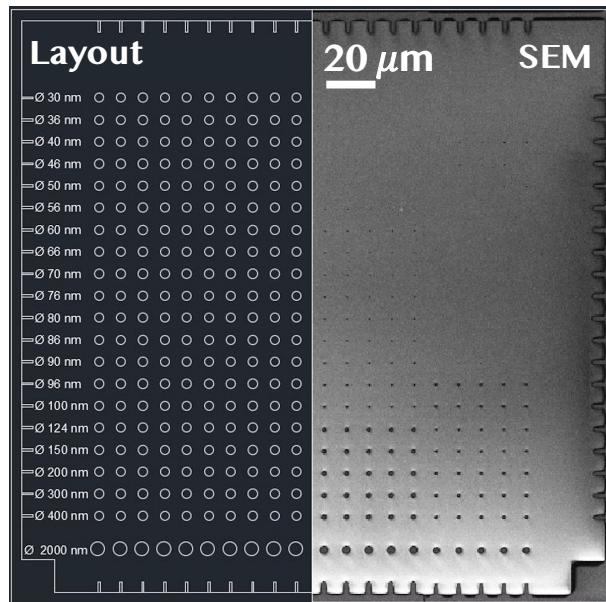
RTA Annealing,
BP 1275/50 nm

Special thanks to
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Wafer-scale nanofabrication of single telecom quantum emitters - Broad beam Si ions

PMMA design / SEM image

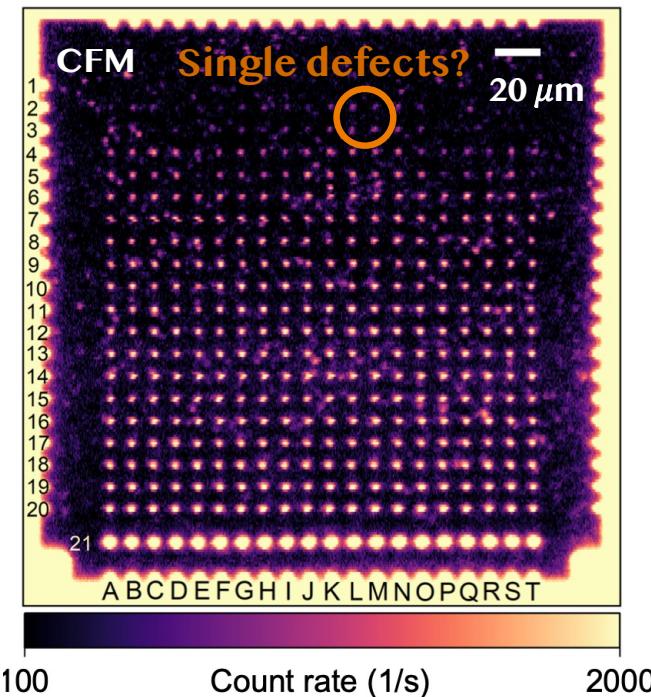
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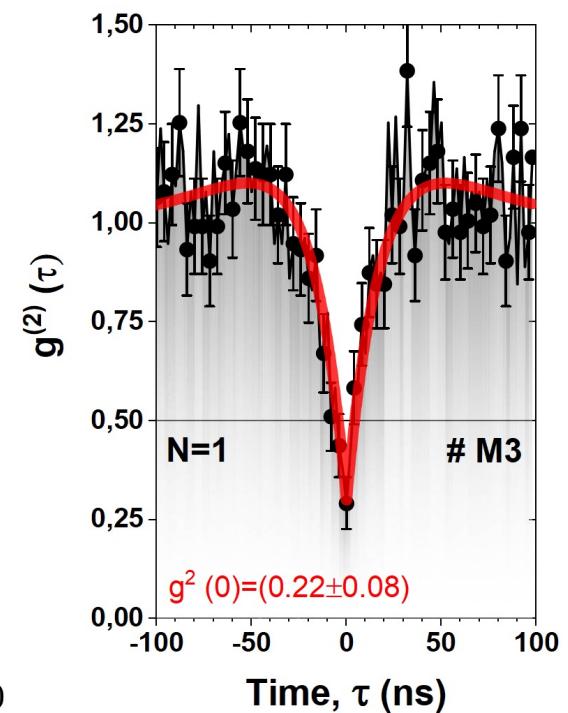
2D confocal PL map

$t_{\text{int}} \sim 2 \text{ days}$



RTA Annealing,
BP 1275/50 nm

HBT- Interferometry



RTA Annealing,
BP 1275/50 nm

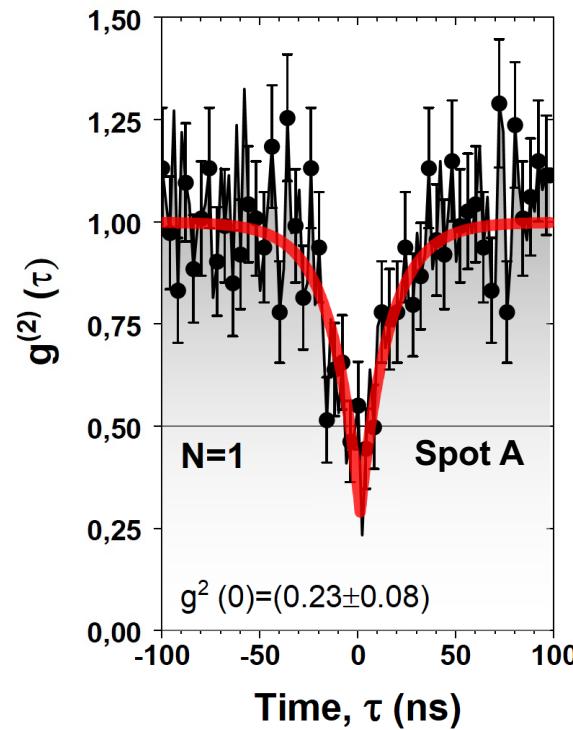
⇒ CMOS compatible fabrication method of single telecom photon emitters

Wafer-scale nanofabrication of single telecom quantum emitters - Broad beam Si ions

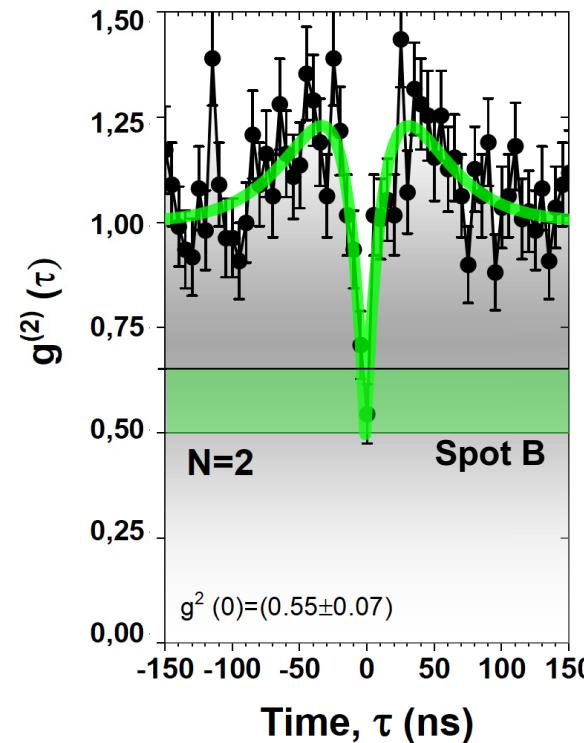
HBT Interferometry - Statistics

Emitter condition:

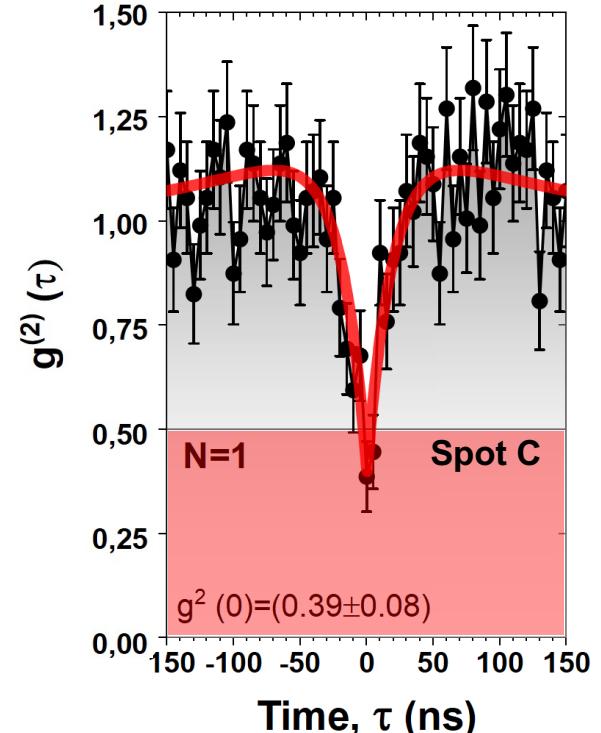
$$g^{(2)}(0) = \frac{N - 1}{N}$$



If $0.5 < g^{(2)}(0) < 0.67$
 $\Rightarrow N=2$



If $g^{(2)}(0) < 0.5$
 $\Rightarrow N=1$

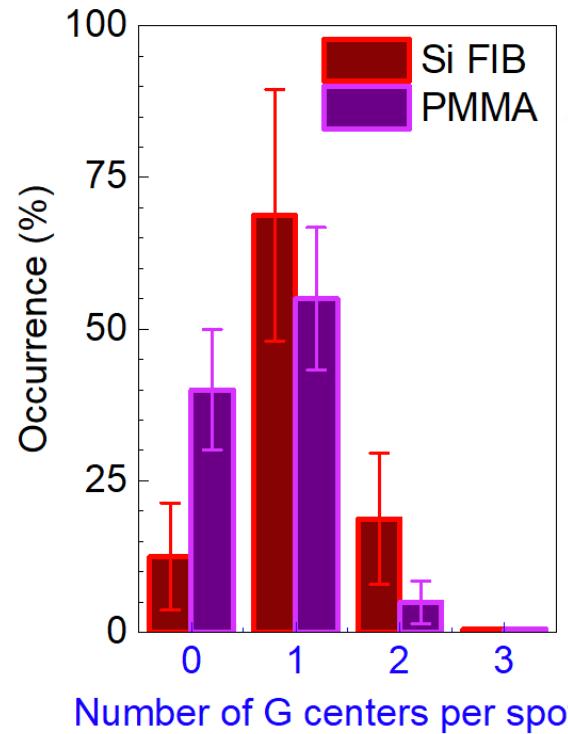


We measure the g^2 function of many spots to

1. determine the number of emitters N
2. calculate the creation probability

Wafer-scale nanofabrication of single telecom quantum emitters – Broad beam Si ions vs. Si FIB

Statistics histogram



⇒ Creation probability > 50%

Optical & spectral properties of single telecom emitters

Statistics histogram

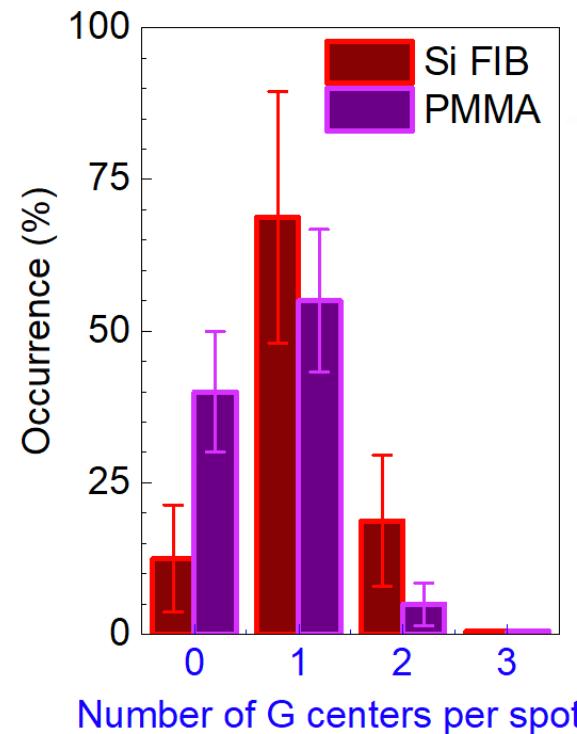
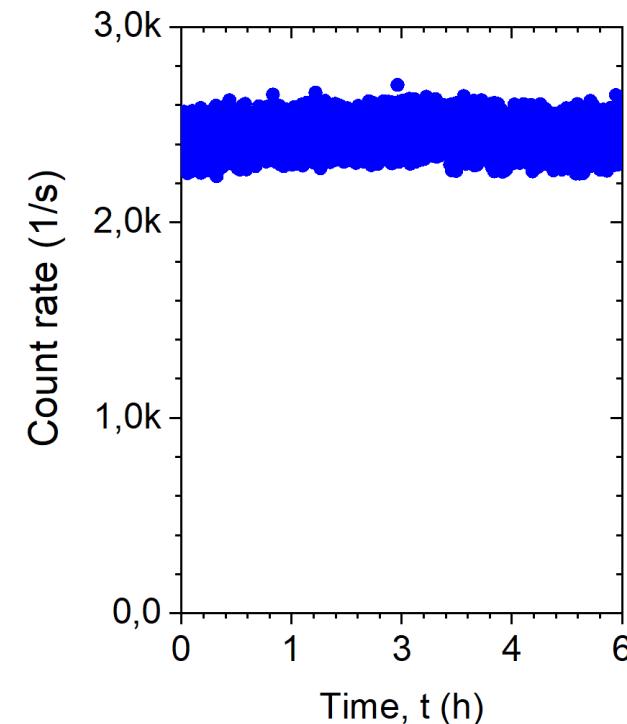


Photo- stability



⇒ Long-term stability over days of operation - No blinking , no bleaching

Optical & spectral properties of single telecom emitters

Statistics histogram

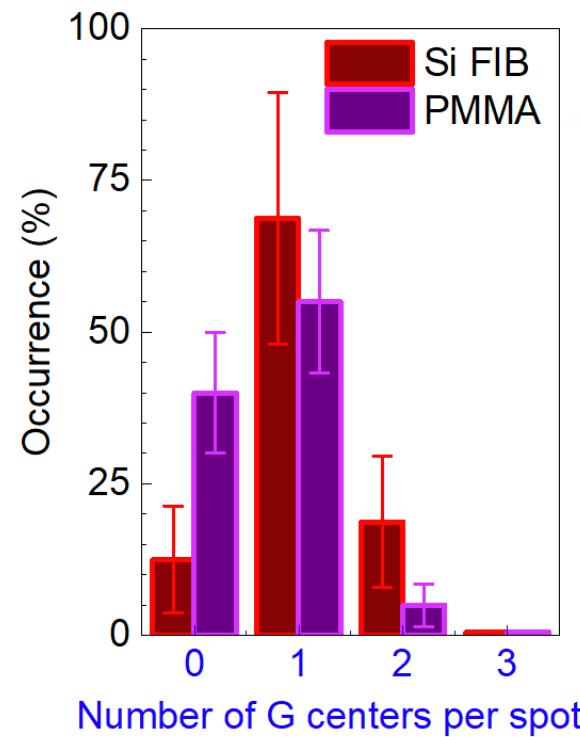
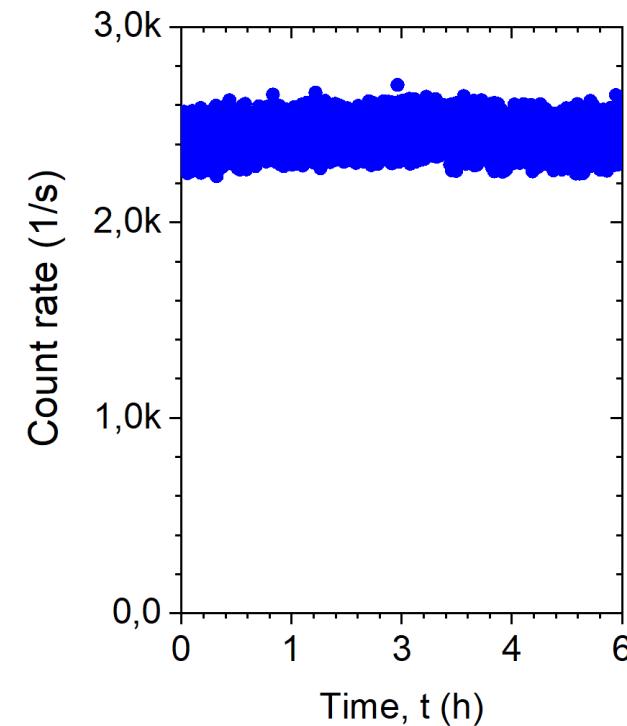
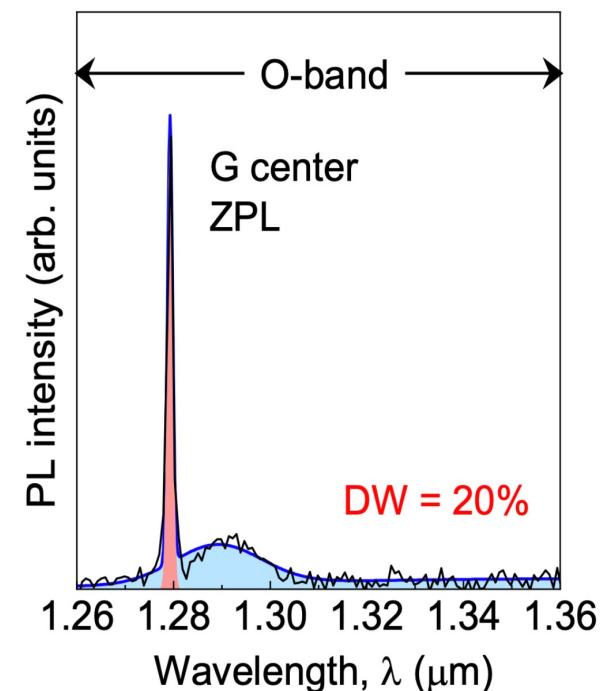


Photo- stability



PL Spectrum of single defect



⇒ No spectral diffusion, spectral position of ZPL nearly equal compared to ensemble

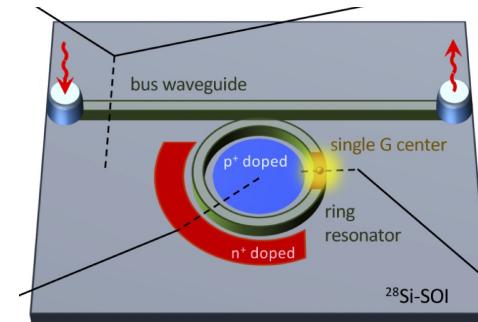
1 Creation of G-centers using FIB in photonic integrated circuits?

Nanopillars, SILS, Cavities, waveguides,...

⇒ Locally down to single level?

⇒ On-chip control?

Local integration & Brightness

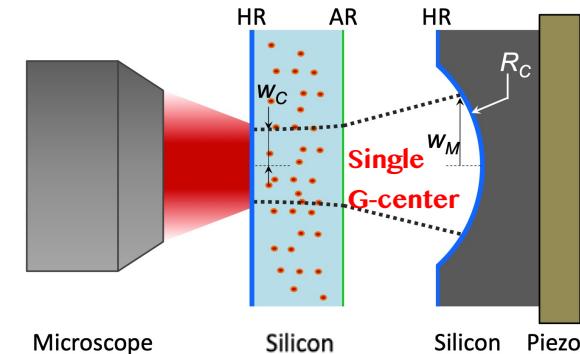


2 Coupling of single G-centers to a Fabry-Pérot microcavity?

PL enhancement?

Spectral stability & lifetime-limited optical linewidth?

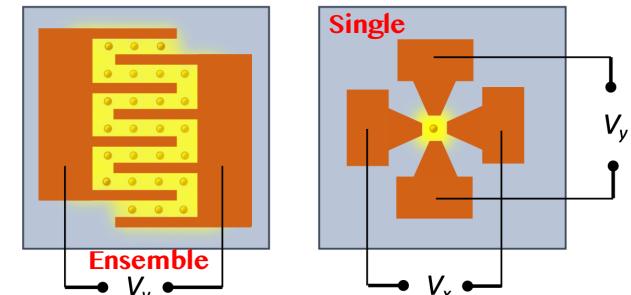
Maximize coupling efficiency



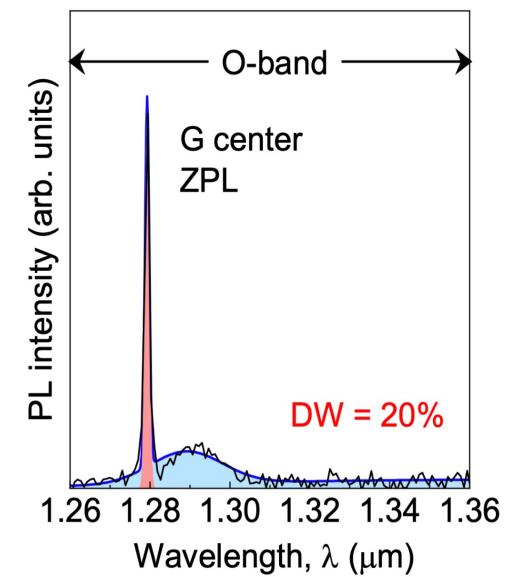
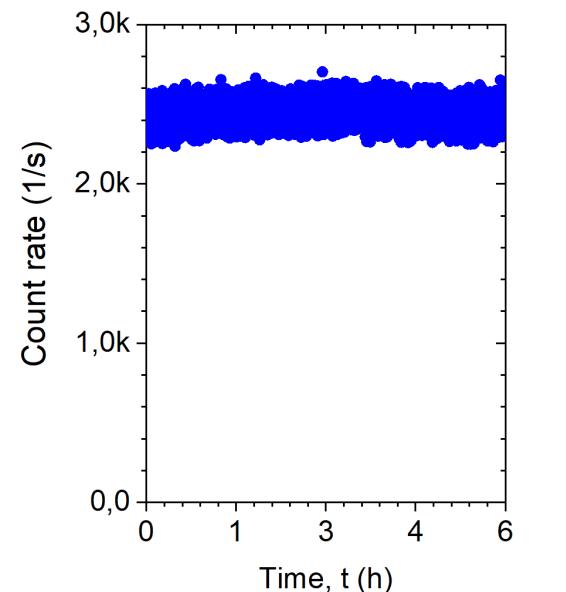
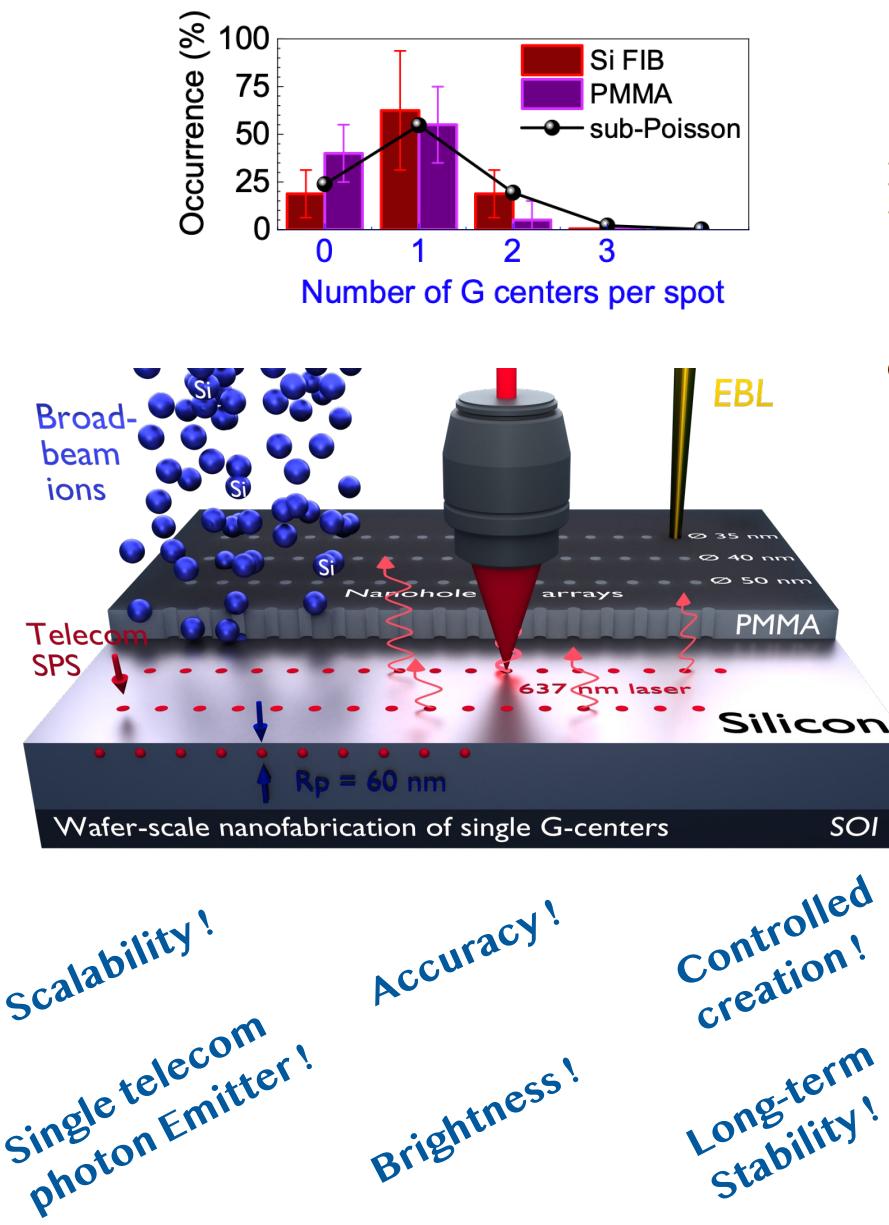
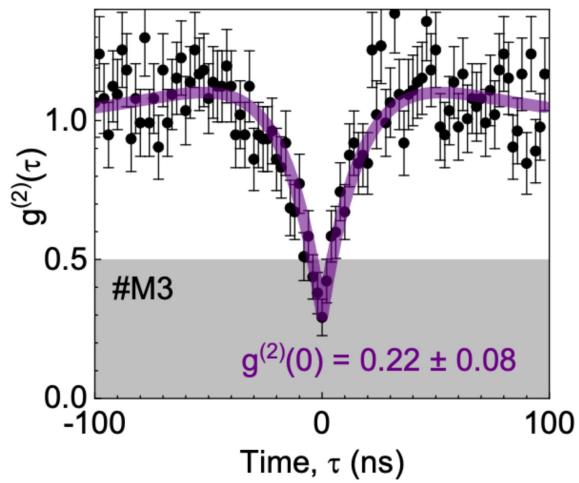
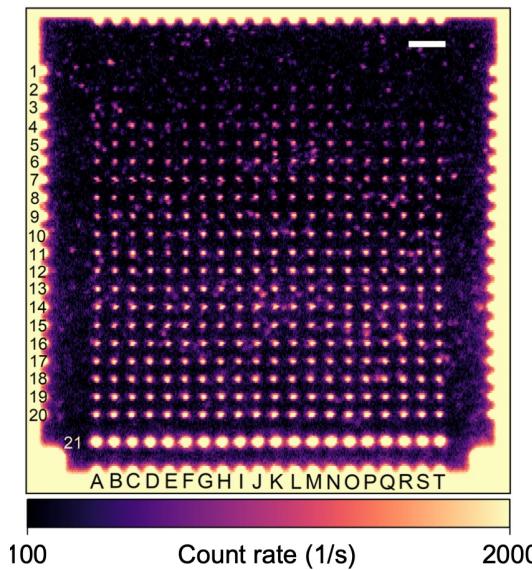
3 Tunability of ZPL emission of single G-center?

Electrical control via Stark-Effect?

Indistinguishability



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Wafer-scale nanofabrication of single telecom quantum emitters in silicon

Thank you for your attention!

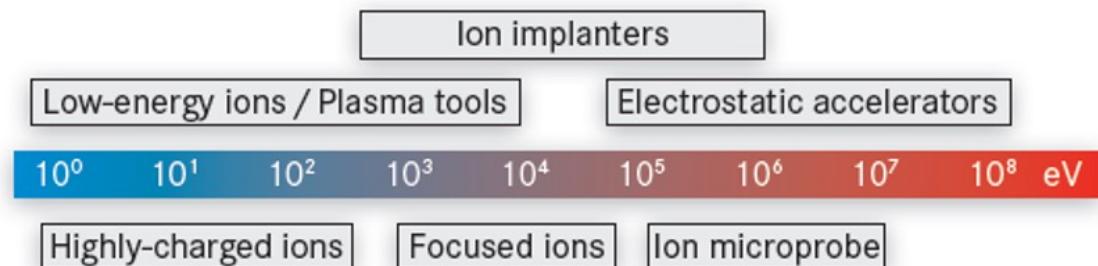
Acknowledgement:

**Y. Berencén
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**N. Klingner
L. Bischoff
N. Jagtap
C. Fowley
L. Rebohle
D. Sobiella
A. Erbe
I. Skorupa**



Ion Beam Center



ION BEAM ANALYSIS

- Elemental mapping and depth profiling
- Light element analysis
- Hydrogen analysis and depth profiling
- Crystal damage analysis
- In-situ process characterization
- Ion microscopy
- Long-lived radionuclides
- Analysis using reactive gases or liquids
- External proton beam

ION BEAM MODIFICATION

- Ion implantation and doping
- Ion-induced ordering/disordering
- Nanostructure fabrication
- Thin-film modification
- Surface patterning
- Surface functionalization
- Ion-induced defect generation
- Nuclear and astrophysical applications
- Fabrication of standards

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Ultra-high precision of processing, nm resolution, broad beams, focused ions, highly-charged ions